



SCHOLARSHIP INFORMATION AND APPLICATION

TAPPI CORRUGATED DIVISION MEMORIAL SCHOLARSHIPS

The purpose of the TAPPI Scholarship Program is to recognize academic excellence, increase awareness and participation in TAPPI's member groups and to attract talented individuals to the industry segments that TAPPI serves.

If you are pursuing an education in the paper and related industries, then TAPPI has many scholarships for which you can qualify. Each scholarship can help open a window of opportunity for you to achieve your personal, educational and professional goals.

TAPPI is the world's largest association for the paper and related industries that:

- Collects and disseminates technical information and technology updates
- Promotes professional growth and competence in the workplace
- Enables employers to address issues of industry concern collectively and cooperatively

Note: This scholarship application is specifically for those candidates applying for the Joe Dieffenbacher Engineering Memorial Scholarship and/or the Terry S. Paulson Memorial Scholarship. The deadline for completed applications for these two scholarships is May 15, 2019. For all other scholarships please use the general scholarship [application](#).

Special Requirements for these scholarships:

- No specific grade point average is required
- Working full time or part time in the corrugated industry and attending day/night school for a graduate or undergraduate degree OR be a full time student in a two-year or a four-year college, university or technical school.
- Demonstrate an interest in the corrugated packaging industry related to maintenance or engineering (part time employment or internships in the corrugated industry are looked upon in a very favorable manner).
- Selection of the scholarship winners will be based on the scholarship committee's opinion of overall maturity, job potential and the candidates' future contribution potential to the corrugated industry.

General Information Form

Send application to: TAPPI Scholarship Department – TAPPI – 15 Technology Pkwy South, Suite 115

Peachtree Corners, GA 30092 or email: scholarships@tappi.org

Address questions to Lisa Lockwood 770-209-7246

Applicant's Name: _____
(Last) (First) (Middle)

Permanent Address

Street _____

City _____ State/Province _____ Postal Code _____

Phone _____ Email _____

University/College Name: _____

Street _____

City _____ State/Province _____ Postal Code _____

Phone _____ Email _____

High School and other Universities/Colleges attended:

Date of anticipated graduation _____

Class status as of September following application deadline (please check the one that applies to you)

- Freshman** **Sophomore** **Junior** **Senior**

Main course of study _____

Are you a TAPPI Student Chapter member? Yes No

If yes, Chapter name _____

List college activities, including leadership roles (clubs, fraternities/sororities, or organizations and list offices held):

List current or previous scholarships received:

Additional activities, hobbies and areas of interest:

List any previous academic achievements or awards:

What person or persons have influenced you most deeply and why?

What single achievement in your life gives you the most pride?

What attracts you to a career in the corrugated industry?

(Optional) Briefly discuss your need for financial assistance:

Do you have any corrugated industry employment experience? Yes No

If yes, name and contact information of employer:

Name _____

Address _____

Phone _____ Email _____

Please attach a resume and transcript or have your school send it directly to TAPPI if applying by email. It is also possible to scan the letters of recommendation and the transcript and email the whole package to the email provided on page 1 of the General Information Form.

Scholarship Checklist

Must be submitted along with the General Information Form

- Completed Scholarship General Information Form
- Official Transcript
- Resume
- Letter of recommendation from a faculty member or Student Chapter advisor
- Two additional letters from persons (other than relatives) who are familiar with the applicant's character, interests, activities and accomplishments.

I hereby acknowledge that the information submitted is true and correct.

Signature _____